# **HIMatrix**

# **Safety-Related Controller**

# F3 DIO 16/8 01 Manual





HIMA Paul Hildebrandt GmbH + Co KG Industrial Automation

Rev. 1.01 HI 800 177 E

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### Contact

HIMA Address
HIMA Paul Hildebrandt GmbH + Co KG
P.O. Box 1261
68777 Brühl, Germany

Tel: +49 6202 709-0

Fax: +49 6202 709-107 E-mail: info@hima.com

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index		technical	editorial	
1.00	Added: Configuration with SILworX	Х	Х	
1.01	Deleted: Chapter <i>Monitoring the Temperature State</i> displaced into the system manual		Х	

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F3 DIO 16/8 01 1 Introduction

### 1 Introduction

This manual describes the technical characteristics of the device and its use. It also includes instructions on how to install, start up and replace it.

### 1.1 Structure and Use of this Manual

The content of this manual is part of the hardware description of the HIMatrix programmable electronic system.

This manual is organized in the following main chapters:

- Introduction
- Safety
- Product Description
- Start-Up
- Operation
- Maintenance
- Decommissioning
- Transport
- Disposal

This manual distinguishes between the following variants of the HIMatrix system:

Programming tool	Processor operating system	
SILworX	Versions Beyond 7	
ELOP II Factory	Versions Prior to 7	

Table 1: HIMatrix System Variants

The manual distinguishes among the different variants using:

- Separated chapters,
- Tables differentiating among the versions, e.g., versions beyond 7, or prior to 7
- $\begin{tabular}{ll} \begin{tabular}{ll} \beg$
- This manual usually refers to compact controllers and remote I/Os as devices, and to the plug-in cards of a modular controller as modules.

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Additionally, the following documents must be taken into account:

Name	Content	Document number
HIMatrix System Manual Compact Systems	Hardware description of the HIMatrix compact systems	HI 800 141 E
HIMatrix System Manual Modular System F60	Hardware description of the HIMatrix modular system	HI 800 191 E
Himatrix Safety Manual	Safety functions of the HIMatrix system	HI 800 023 E
HIMatrix Engineering Manual	Project planning description for HIMatrix systems	HI 800 101 E
SILworX Online Help	Instructions on how to use SILworX	-
ELOP II Factory Online Help	Instructions on how to use ELOP II Factory, Ethernet IP protocol, INTERBUS protocol	-
First Steps SILworX	Introduction to SILworX using the HIMax system as an example	HI 801 103 E
First Steps ELOP II Factory	Introduction to ELOP II Factory	HI 800 006 E

Table 2: Additional Relevant Documents

The latest manuals can be downloaded from the HIMA website www.hima.com. The revision index on the footer can be used to compare the current version of existing manuals with the Internet edition.

# 1.2 Target Audience

This document addresses system planners, configuration engineers, programmers of automation devices and personnel authorized to implement, operate and maintain the modules and systems. Specialized knowledge of safety-related automation systems is required.

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F3 DIO 16/8 01 1 Introduction

# 1.3 Formatting Conventions

To ensure improved readability and comprehensibility, the following fonts are used in this document:

**Bold:** To highlight important parts

Names of buttons, menu functions and tabs that can be clicked and

used in the programming tool.

Italics: For parameters and system variables

Courier Literal user inputs

RUN Operating state are designated by capitals

Chapter 1.2.3 Cross references are hyperlinks even though they are not

particularly marked. When the cursor hovers over a hyperlink, it changes its shape. Click the hyperlink to jump to the corresponding

position.

Safety notes and operating tips are particularly marked.

# 1.3.1 Safety Notes

The safety notes are represented as described below.

These notes must absolutely be observed to reduce the risk to a minimum. The content is structured as follows:

- Signal word: danger, warning, caution, notice
- Type and source of danger
- Consequences arising from the danger
- Danger prevention

### **A** SIGNAL WORD



Type and source of danger!

Consequences arising from the danger

Danger prevention

The signal words have the following meanings:

- Danger indicates hazardous situation which, if not avoided, will result in death or serious injury.
- Warning indicates hazardous situation which, if not avoided, could result in death or serious injury.
- Warning indicates hazardous situation which, if not avoided, could result in minor or modest injury.
- Notice indicates a hazardous situation which, if not avoided, could result in property damage.

### **NOTE**



Type and source of damage! Damage prevention

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# 1.3.2 Operating Tips Additional information is structured as presented in the following example: The text corresponding to the additional information is located here. Useful tips and tricks appear as follows: TIP The tip text is located here.

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F3 DIO 16/8 01 2 Safety

# 2 Safety

The following safety information, notes and instructions must be strictly observed. The product may only be used if all guidelines and safety instructions are adhered to.

This product is operated with SELV or PELV. No imminent danger results from the product itself. The use in Ex-Zone is permitted if additional measures are taken.

### 2.1 Intended Use

HIMatrix components are designed for assembling safety-related controller systems.

When using the components in the HIMatrix system, comply with the following general requirements

# 2.1.1 Environmental Requirements

Requirement type	Range of values 1)		
Protection class	Protection class III in accordance with IEC/EN 61131-2		
Ambient temperature	0+60 °C		
Storage temperature	-40+85 °C		
Pollution	Pollution degree II in accordance with IEC/EN 61131-2		
Altitude	< 2000 m		
Housing	Standard: IP20		
Supply voltage	24 VDC		
The values specified in the technical data apply and are decisive for devices with			

The values specified in the technical data apply and are decisive for devices with extended environmental requirements.

Table 3: Environmental Requirements

Exposing the HIMax system to environmental conditions other than those specified in this manual can cause the HIMatrix system to malfunction.

### 2.1.2 ESD Protective Measures

Only personnel with knowledge of ESD protective measures may modify or extend the system or replace devices.

### NOTE



Device damage due to electrostatic discharge!

- When performing the work, make sure that the workspace is free of static, and wear an ESD wrist strap.
- If not used, ensure that the device is protected from electrostatic discharge, e.g., by storing it in its packaging.

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## 2.2 Residual Risk

No imminent danger results from a HIMatrix system itself.

Residual risk may result from:

- Faults in the engineering
- Faults in the user program
- Faults in the wiring

# 2.3 Safety Precautions

Observe all local safety requirements and use the protective equipment required on site.

# 2.4 Emergency Information

A HIMatrix system is a part of the safety equipment of a site. If a device or a module fails, the site adopts the safe state.

In case of emergency, no action that may prevent the HIMatrix systems from operating safely is permitted.

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# 3 Product Description

The safety-related **F3 DIO 16/8 01** remote I/O is a compact system in a metal enclosure with 16 digital inputs, 8 two-pole digital outputs and 2 pulsed outputs. The two-pole outputs consist of 2 switches connected in series, one switching to L+ and the other switching to L-.

The remote I/O is available in a model variant for SILworX and a model variant for ELOP II Factory. All variants are described in this manual.

The remote I/O serves to extend the I/O level of HIMax and HIMatrix controllers, and is connected to them via safe**ethernet**. The remote I/O itself is not able to run a user program.

The HIMatrix remote I/Os are not multi-master capable.

The remote I/O is suitable for mounting in Ex-zone 2, see Chapter 4.1.5.

The device has been certified by the TÜV for safety-related applications up to SIL 3 (IEC 61508, IEC 61511 and IEC 62061), Cat. 4 (EN 954-1) and PL e (EN ISO 13849-1). Further safety standards, application standards and test standards are specified in the certificate available on the HIMA website.

# 3.1 Safety Function

The remote I/O is equipped with safety-related digital inputs and outputs. The input values on the inputs are safely transmitted to the connected controller via safe**ethernet**. The outputs are safely assigned their values by the connected controller via safe**ethernet**.

# 3.1.1 Safety-Related Digital Inputs

The state (HIGH, LOW) of each input is signaled by an individual LED.

Mechanical contacts without own power supply or signal power source can be connected to the inputs. Potential-free mechanical contacts without own power supply are fed via an internal short-circuit-proof 24 V power source (LS+). Each of them supply a group of 4 mechanical contacts. Figure 1 shows how the connection is performed.

With signal voltage sources, the corresponding ground must be connected to the input (L-), see Figure 1.

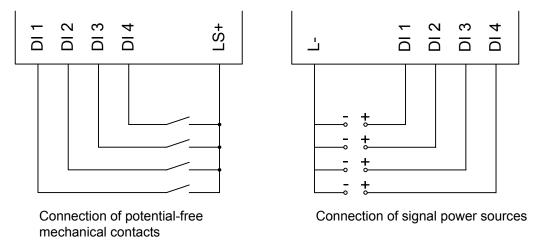


Figure 1: Connections to Safety-Related Digital Inputs

Table 17 shows the entire terminal assignment for the digital inputs.

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In the default setting, each of the 24V power sources (LS+) provides a current of 40 mA which is buffered against power failures for 20 ms.

If higher current is required, the *DI Supply[xx]* system parameter can be set in the user program to connect an unbuffered power source (1 A) for each terminal pair (33, 34 and 43, 44) and (53, 54 and 63, 64), see Figure 2 and Figure 3.

The remote I/O reads back the state of the unbuffered power sources and if an overload occurs, it switches off. The power sources are protected with current limiting components.

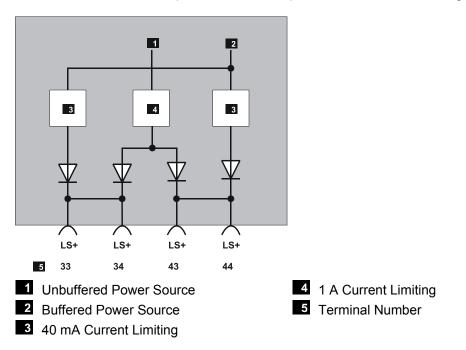


Figure 2: Exemplary Structure of Buffered and Unbuffered Power Source

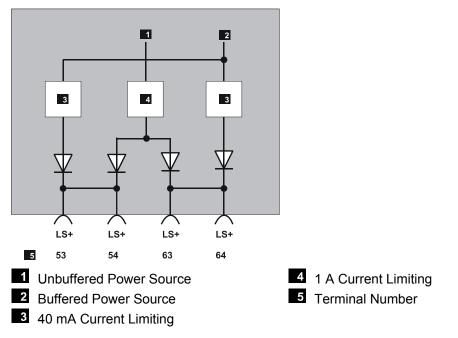


Figure 3: Exemplary Structure of Buffered and Unbuffered Power Source

The connector cables for the inputs are not monitored.

It is not necessary to terminate unused inputs.

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### 3.1.1.1 Reaction in the Event of a Fault

If the device detects a fault on a digital input, the user program processes a low level in accordance with the de-energized to trip principle.

The device activates the FAULT LED.

In addition to the channel signal value, the user program must also consider the corresponding error code.

The error code allows the user to configure additional fault reactions in the user program.

### 3.1.2 Line Control

Line control is used to detect short-circuits or open-circuits and can be configured for the remote I/O, e.g., on EMERGENCY STOP inputs complying with Cat. 4 in accordance with EN 954-1.

To this end, connect the pulsed outputs TO 1...TO 2 of the system to the digital inputs (DI) of the same system as follows:

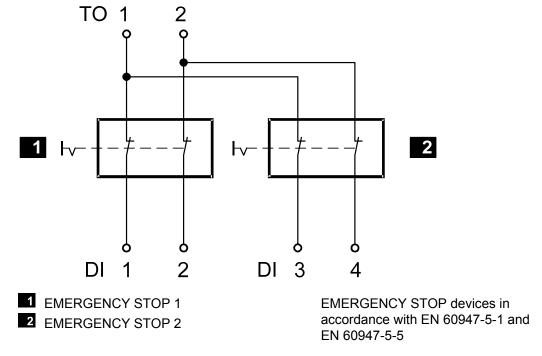


Figure 4: Line Control

The remote I/O pulses the pulsed outputs to detect short-circuits and open-circuits on the digital inputs (DI). To do so, configure the *Value*.[BOOL] -> system variable in SILworX and the *DO[0x]*. *Value* system signal in ELOP II Factory. The variables for the pulsed outputs must begin with channel 1 and reside in direct sequence, one after the other.

If the following faults occur, the *FAULT* LED located on the front plate of the controller blinks, the inputs are set to low level and an (evaluable) error code is created:

- Cross-circuit between two parallel lines,
- Improper connections of two lines (e.g., TO 2 to DI 3),
- Earth fault of a line (with earthed ground only),
- Open-circuit or open contacts, i.e., including when one of the two EMERGENCY STOP switches mentioned above has been engaged, the FAULT LED blinks and the error code is created.

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For more information on how to configure line control in the user program, refer to the HIMatrix Engineering Manual HI 800 101 E.

# 3.1.3 Safety-Related Digital Outputs

The state (HIGH, LOW) of each output is signaled by an individual LED. The following block diagram shows how the two-pole digital outputs are connected:

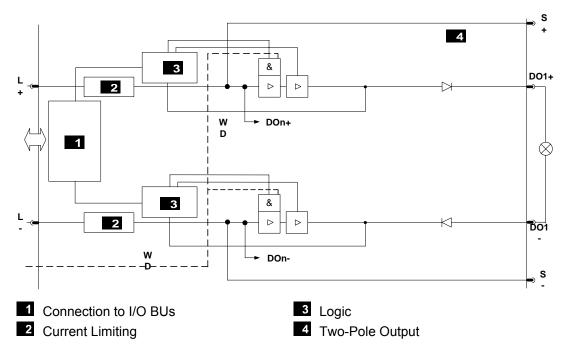


Figure 5: Block Diagram for Two-Pole Digital Outputs

The 1002 processor system directly energizes the digital outputs. Field zone and processor zone are not galvanically isolated. The operating voltage directly supplies the outputs.

If a critical fauilure occurs, the processor system brings the outputs to the de-energized state directly, via the I/O bus or indirectly, using the watchdog (second independent shutdown function).

If communication is lost, the output is set to the initial value configured. This effect must be taken into account for the behavior of the connected output.

If an overload occurs, one or all digital outputs are switched off. If the overload is removed, the outputs are switched on again automatically, see Table 14.

### 3.1.3.1 Reaction in the Event of a Fault

If the device detects a faulty signal on a digital output, the affected module output is set to the safe (de-energized) state using the safety switches.

If a fault in the device occurs, all digital outputs are switched off.

In both cases, the devices activates the FAULT LED.

The error code allows the user to configure additional fault reactions in the user program.

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# 3.1.4 Line Diagnosis with Digital Outputs

The remote I/O is provided with a line diagnosis (short-circuits and open-circuits) for the digital outputs. The line diagnosis is activated using the *Line Monitoring [BOOL]* -> system variable in SILworX and the *DO[xx].LSLB Monitoring* system signal in ELOP II Factory.

The line diagnosis measures the impedance of the connected load such as described in the following section.

The line diagnosis detects the following faults:

- Short-circuit between DO+ and external DO-
- Short-circuit between DO+ and external L+
- Short-circuit between DO+ and external L-
- Short-circuit between DO- and external L+
- Short-circuit between DO- and external L-
- Open-circuit between DO+ and DO-

Line diagnosis of the digital outputs is only possible when used in a two-pole configuration.

The line diagnosis reports detected faults to the user program.

- In SILworX, using the system variables -> + Error Code [WORD] or -> Error Code [WORD].
- In ELOP II Factory, using the system signals DO[xx].+Error Code or DO[xx].-Error Code.

Line diagnosis is offered in two operating modes:

- Line diagnosis for lamp loads and inductive loads, and
- line diagnosis for ohmic, capacitive loads.
- With applications in accordance with EN 954-1 Cat. 4, the line diagnosis status signal must be used to switch off the outputs (DO+, DO-), if a failure occurs.
- If the requirements previously described cannot be met, observe the following case:

  If a short-circuit occurs between DO- and L-, a relay may be energized or some other actuator may be set to a different switching state.

Reason: During the monitoring time specified for line diagnosis, a 24V voltage level (DO+ output) is present on the load (relay, switching actuator) allowing it to receive enough electrical power to potentially switch to another state.

With line diagnosis, set a test period and an adequate monitoring time.

### 3.1.4.1 Line Diagnosis for Lamp Loads and Inductive Loads

To detect short-circuits, the remote I/O sends a 24V pulse to the output circuit for the duration of 500  $\mu$ s. After this time, it sends a 10V pulse for line diagnosis for the duration of the monitoring time.

# 3.1.4.2 Line Diagnosis for Ohmic, Capacitive Loads

To diagnose the line for ohmic and capacitive loads, the remote I/O sends a 10V test pulse to the output circuit for the duration of the monitoring time. This type of line diagnosis is particularly recommended for ohmic and ohmic capacitive loads. With inductive loads or lamp loads, error messages related to the short-circuit may be generated.

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# 3.1.4.3 Test Period and Monitoring Time

For line diagnosis, configure the test period and the monitoring time. These time parameters influence all the channels configured for line diagnosis.

During the monitoring time, the status is read back in 1 ms intervals and, if no faults are detected, the process values are rewritten to the output. The monitoring time can be set in intervals of 1 ms between 0 and 50 ms (default value 0 ms).

 $\begin{tabular}{ll} \hline 1 & The duration of the monitoring time is added to the cycle time. During the monitoring time, the output circuit is supplied with a reduced voltage. \\ \hline \end{tabular}$ 

The time period can be configured in intervals of 1 second between 1 and 100 seconds. The interval depends on following parameters:

- Number of test pulses allowed in the external circle
- Monitoring time

If the time period is set to 1 second, a test pulse is sent in intervals of 250 ms for the duration of the monitoring time.

Within one test period, 4 test pulses are generally pulsed in intervals of 0.25 seconds.

After the period time the line diagnosis is finished and the next line diagnosis cycle starts.

# 3.2 Equipment, Scope of Delivery

The available variants and their part numbers are listed below:

Designation	Description	Part no.	
F3 DIO 16/8 01	Remote I/O with 16 digital inputs, 8 digital outputs and 2 pulsed outputs, operating temperature 0+60 °C, for ELOP II Factory programming tool.	98 2200423	
F3 DIO 16/8 01 SILworX	Remote I/O with 16 digital inputs, 8 digital outputs and 2 pulsed outputs, operating temperature 0+60 °C for SILworX programming tool.	98 2200486	

Table 4: Part Numbers

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# 3.2.1 IP Address and System ID (SRS)

A transparent label is delivered with the device to allow one to note the IP address and the system ID (SRS for system rack slot) after a change.

IP\_\_\_.\_\_.SRS\_\_\_.\_.

Default value for IP address: 192.168.0.99

Default value for SRS: 60000.200.0 (SILworX)

60000.0.0 (ELOP II Factory)

The label must be affixed such that the ventilation slots in the housing are not obstructed.

Refer to the First Steps manual of the programming tool for more information on how to modify the IP address and the system ID.

## 3.3 Type Label

The type plate contains the following details:

- Product name
- Bar code (1D or 2D code)
- Part no.
- Production year
- Hardware revision index (HW Rev.)
- Firmware revision index (FW Rev.)
- Operating voltage
- Mark of conformity



Figure 6: Sample Type Label

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### 3.4 **Assembly**

This chapter describes the layout and function of the remote I/Os, and their communication via safe**ethernet**.

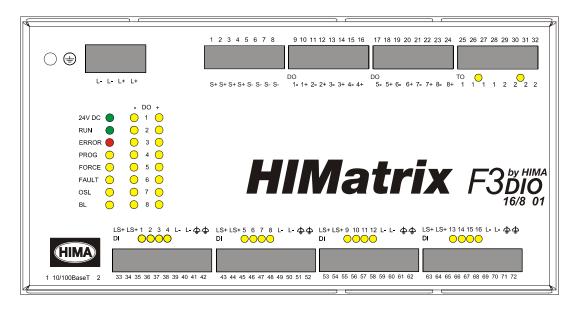
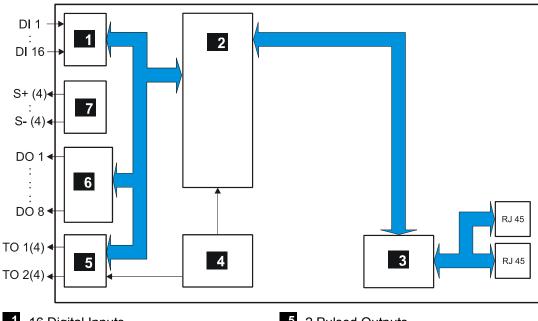


Figure 7: Front View



- 16 Digital Inputs
- Safety-Related Processor System
- **Ethernet Switch**
- 4 Watchdog

Figure 8: **Block Diagram** 

- 5 2 Pulsed Outputs
- 8 Digital Outputs, Two-Pole (DO+, DO-)
- **Ground for Digital Outputs**

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# 3.4.1 LED Indicators

The light-emitting diodes (LEDs) indicate the operating state of the remote I/O. The LEDs are classified as follows:

- Operating voltage LED
- System LEDs
- Communication LEDs
- I/O LEDs

# 3.4.1.1 Operating Voltage LED

LED	Color	Status	Description
24 VDC	Green	On	24 VDC operating voltage present
		Off	No operating voltage

Table 5: Operating Voltage LED

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# 3.4.1.2 System LEDs

While the system is being booted, all LEDs are lit simultaneously.

LED	Color	Status	Description
RUN	Green	On	Device in RUN, normal operation
			A loaded user program is being executed (not with remote I/Os).
		Blinking	Device in STOP
			A new operating system is being loaded.
		Off	The device is not in the RUN state.
ERROR	Red	On	The device is in the ERROR STOP state.
			Internal fault detected by self-tests
			e.g., hardware fault, software error or cycle time overrun.
			The processor system can only be restarted with a command from the PADT (reboot).
		Blinking	If ERROR blinks and all others LEDs are lit simultaneously, the boot loader has detected an operating system fault in the flash memory and waits for a new operating system to be loaded.
		Off	No faults detected.
PROG	Yellow	On	A new configuration is being loaded into the device.
		Blinking	The device switches from INIT to STOP
			A new operating system is being loaded into the flash ROM.
		Off	No configuration or operating system is being loaded.
FORCE	<b>Yellow</b>	On	The device is in RUN, forcing was activated.
		Blinking	The device is in STOP, forcing has been prepared and is activated when the device is started.
		Off	Forcing is not activated.  The FORCE LED of a remote I/O is not functioning. The FORCE LED of the associated controller serves to signal the forcing of a remote I/O.
FAULT	Yellow	On	The loaded configuration is defective.
			The new operating system is corrupted (after OS download).
		Blinking	Fault while loading a new operating system
			One or multiple I/O faults occurred.
		Off	None of the described faults occurred.
OSL	<b>Yellow</b>	Blinking	Operating system emergency loader active.
		Off	Operating system emergency loader inactive.
BL	Yellow	Blinking	OS and OLS binary defective or INIT_FAIL hardware fault.
		Off	Boot loader inactive

Table 6: System LEDs

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# 3.4.1.3 Communication LEDs

All RJ-45 connectors are provided with a small green and a yellow LEDs. The LEDs signal the following states:

LED	Status	Description			
Green	On	Full duplex operation			
	Blinking	Collision			
	Off	Half duplex operation, no collision			
<b>Yellow</b>	On	Connection available			
	Blinking	Interface activity			
	Off	No connection available			

Table 7: Ethernet Indicators

# 3.4.1.4 I/O LEDs

LED	Color	Status	Description	
DI 116	Yellow	On	On The related channel is active (energized).	
		Off	The related channel is inactive (de-energized).	
DO 18	Yellow	On	The related output is active (energized).	
		Off	The related output is inactive (de-energized).	
TO 12	Yellow	On	Pulsed output activated.	
		Off	Pulsed output deactivated.	

Table 8: I/O LEDs

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### 3.4.2 Communication

The remote I/O communicates with the associated controller via safeethernet.

### 3.4.2.1 Connections for Ethernet Communication

Property	Description	
Port	2 x RJ-45	
Transfer standard	10/100/Base-T, half and full duplex	
Auto negotiation	Yes	
Auto crossover	Yes	
Connection socket	RJ-45	
IP address	Freely configurable <sup>1)</sup>	
Subnet mask	Freely configurable <sup>1)</sup>	
Supported protocols	Safety-related: safeethernet	
	Non-safety-related:	
	programming and debugging tool (PADT), SNTP	
The general rules for assigning IP address and subnet masks must be adhered to.		

Table 9: Ethernet Interfaces Properties

The two RJ-45 connectors with integrated LEDs are located on the bottom left-hand side of the enclosure. For more information on the communication LEDs, refer to Chapter 3.4.1.3.

The connection parameters are read based on the MAC address (media access control address) defined during manufacturing.

The MAC address for the remote I/O is specified on a label located above the two RJ-45 connectors (1 and 2).

MAC 00:E0:A1:00:06:C0

Figure 9: Sample MAC Address Label

The remote I/O is equipped with an integrated switch for safety-related Ethernet communication (safe**ethernet**). For further information on the integrated switch and safe**ethernet**, refer to Chapter Communication of the System Manual for Compact Systems (HI 800 141 E).

## 3.4.2.2 Network Ports Used for Ethernet Communication

UDP ports	Usage
8000	Programming and operation with the programming tools
8001	Configuration of the remote I/O using the PES (ELOP II Factory)
8004	Configuration of the remote I/O using the PES (SILworX)
6010	safeethernet
123	SNTP (time synchronization between PES and remote I/O, PES and external devices)

Table 10: Network Ports in Use

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### 3.4.3 Pulsed Outputs

The 2 digital pulsed outputs can be used for line control to detect short-circuits and open-circuits on digital inputs, e.g., on an EMERGENCY STOP button complying with Cat. 4 in accordance with EN 954-1.

 $\dot{1}$  Pulsed outputs must not be used as safety-related outputs (e.g., for activating safety-related actuators)!

### 3.4.4 Reset Key

The remote I/O is equipped with a reset key. The key is only required if the user name or password for administrator access is not known. If only the IP address set for the remote I/O does not match the PADT (PC), the connection can be established with a Route add entry on the PC.

The key can be accessed through a small round hole located approximately 5 cm from the upper left-hand side of the enclosure. The key is engaged using a suitable pin made of insulating material to avoid short-circuits within the remote I/O.

The reset is only effective if the remote I/O is rebooted (switched off and on) while the key is simultaneously engaged for at least 20 seconds. Engaging the key during operation has no effect.

Properties and behavior of the remote I/IO after a reboot with engaged reset key:

- Connection parameters (IP address and system ID) are set to the default values.
- All accounts are deactivated except for the administrator default account with empty password.

After a new reboot without the reset key engaged, the connection parameters (IP address and system ID) and accounts become effective.

- Those configured by the user.
- Those valid prior to rebooting with the reset key engaged, if no changes were performed.

### 3.4.4.1 Ampacity of the Digital Outputs

The ampacity of the digital outputs depends on the temperature. The following table specifies channel-related current loads that should maintain the temperature load of the outputs below the critical limit.

	Output channel					Ambient			
	1	2	3	4	5	6	7	8	temperature
max. current	2 A	0.5 A	1 A	0.5 A	0.5 A	1 A	0.5 A	2 A	< 40 °C with free convection
max. current	1 A	0.5 A	1 A	0.5 A	0.5 A	1 A	0.5 A	1 A	> 40 °C with free convection

Table 11: Ampacity of the Digital Outputs

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# 3.5 Product Data

General		
Response time ≥ 10 ms		
Ethernet interfaces	2 x RJ-45, 10/100BaseT (with 100 Mbit/s)	
	with integrated switch	
Operating voltage	24 VDC, -15 %+20 %, w <sub>ss</sub> ≤ 15 %,	
	from a power supply unit with safe insulation	
	in accordance with IEC 61131-2	
Current input	max. 11 A (with maximum load)	
	at UL, only 10 A allowed	
	Idle current: 0.45 A	
Fuse (external)	On site, 12 A time-lag	
Operating temperature	0 °C+60 °C	
Storage temperature	-40 °C+85 °C	
Type of protection	IP20	
Max. dimensions	Width: 205 mm (with enclosure screws)	
(without plug)	Height: 114 mm (with fixing bolt)	
	Depth: 88 mm (with earth)	
Weight	1.3 kg	

Table 12: Product Data of F3 DIO 16/8 01

Digital inputs		
Number of inputs 16 (non-galvanically isolated)		
High level: voltage	1530 VDC	
current input	≥ 2 mA at 15 V	
Low level: voltage	max. 5 VDC	
current input	max. 1.5 mA (1 mA at 5 V)	
Switching point	typ. 7.5 V	
Switching time	250 μs	
Supply	4 x LS+ minus 4 V / 40 mA, short-circuit-proof	
	Buffered for 20 ms	
	2x LS+ minus 2 V / 1 A total, short-circuit-proof, unbuffered	
	Current input: max. 1 A at 60 °C	

Table 13: Specifications for the Digital Inputs

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Digital outputs			
Number of outputs	8 (non-galvanically isolated)		
	Two-pole switching		
	DO+ 2A (inrush current ty	p. 10 A at 2 ms)	
	DO- 2A (inrush current typ	o. 10 A at 2 ms)	
Output voltage	≥ L+ minus voltage drop (l	_+ and L- leg)	
Voltage drop	max. 3 V at 2A		
Two-pole outputs			
Voltage drop	max. 1.5 V at 2A		
Outputs DO+			
Voltage drop	max. 1.5 V at 2A		
Outputs DO-			
Output current	max. 2 A at 40 C°		
See also Table 11	max. 1 A at 60 C°		
	min. 10 mA		
Total permissible current	max. 8 A		
Leakage current (with low level)	max. 1 mA at 2 V		
Lamp load	max. 25 W		
Inductive load	max. 500 mH		
Line diagnosis	Open-circuit	> 4 kΩ	
	Short-circuit	< 10 Ω	
Behavior with overload	The affected output is switched off and		
	cyclically switched on aga	in	

Table 14: Specifications for the Digital Outputs

Pulsed outputs			
Number of outputs 2 (non-galvanically isolated)			
Output voltage	≥ L+ minus 4 V		
Output current	approx. 60 mA		
Minimum load	None		
Switching time	≤ 100 μs		
Behavior with overload	2 x ≥ 19.2 V, short-circuit current 60 mA at 24 V		

Table 15: Specifications for the Pulsed Outputs

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# 3.6 Certified HIMatrix F3 DIO 16/8 01

Test institute	Standard, Scope		
CE	EMC, ATEX Zone 2		
TÜV	IEC 61508 1-7:2000 up to SIL 3		
	IEC 61511:2004		
	EN 954-1:1996 up to Cat. 4		
TÜV ATEX	94/9/EG		
	EN 1127-1		
	EN 61508		
UL Underwriters	ANSI/UL 508, NFPA 70 – Industrial Control Equipment		
Laboratories Inc.	CSA C22.2 No.142		
	UL 1998 Software Programmable Components		
	NFPA 79 Electrical Standard for Industrial Machinery		
	IEC 61508		
FM Approvals	Class I, DIV 2, Groups A, B, C and D		
	Class 3600, 1998		
	Class 3611, 1999		
	Class 3810, 1989		
	Including Supplement #1, 1995		
	CSA C22.2 No 142		
	CSA C22.2 No 213		

Table 16: Certificates

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# 4 Start-Up

To start up the remote I/O, it must be mounted, connected and configured in the programming tool.

# 4.1 Installation and Mounting

The remote I/O is mounted on a 35 mm DIN rail such as described in the HIMatrix System Manual for Compact Systems.

# 4.1.1 Installation and Terminals of the Digital Inputs

Terminal	Designation	Function		
33, 34	LS+	Sensor supply for inputs 14, buffered/unbuffered supply.		
35	1	Digital input 1		
36	2	Digital input 2		
37	3	Digital input 3		
38	4	Digital input 4		
39, 40	L-	Ground		
41, 42	PA	Shielding		
Terminal	Designation	Function		
43, 44	LS+	Sensor supply for inputs 58, buffered/unbuffered supply.		
45	5	Digital input 5		
46	6	Digital input 6		
47	7	Digital input 7		
48	8	Digital input 8		
49, 50	L-	Ground		
51, 52	PA	Shielding		
Terminal	Designation	Function		
53, 54	LS+	Sensor supply for inputs 912, buffered/unbuffered supply.		
55	9	Digital input 9		
56	10	Digital input 10		
57	11	Digital input 11		
58	12	Digital input 12		
59, 60	L-	Ground		
61, 62	PA	Shielding		
Terminal	Designation	Function		
63, 64	LS+	Sensor supply for inputs 1316, buffered/unbuffered supply.		
65	13	Digital input 13		
66	14	Digital input 14		
67	15	Digital input 15		
68	16	Digital input 16		
69, 70	L-	Ground		
71, 72	PA	Shielding		

Table 17: Terminal Assignment for the Digital Inputs

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# 4.1.2 Surges on Digital Inputs

Due to the short cycle time of the HIMatrix systems, a surge pulse as described in EN 61000-4-5 can be read in to the digital inputs as a short-term high level.

The following measures ensure proper operation in environments where surges may occur:

- 1. Install shielded input wires
- Activate noise blanking: a signal must be present for at least two cycles before it is evaluated.
- $oldsymbol{1}$  Activating noise blanking increases the response time of the HIMatrix system!
- $\overset{\centerdot}{1} \qquad \text{The measures specified above are not necessary if the plant design precludes surges from occurring within the system.}$

In particular, the design must include protective measures with respect to overvoltage, lightning, earth grounding and plant wiring in accordance with the relevant standards and the instructions specified in the System Manual (HI 800 141 or HI 800 191).

# 4.1.3 Installation and Terminals of the Digital Inputs

Use the following terminals to connect the digital outputs:

Terminal	Designation Function (outputs)	
14	S+ Positive sensor supply	
58	S-	Negative sensot supply
Terminal	Designation	Function (outputs)
9	1-	Digital output 1, S+ switching
10	1+	Digital output 1, S- switching
11	2-	Digital output 2, S+ switching
12	2+	Digital output 2, S- switching
13	3-	Digital output 3, S+ switching
14	3+ Digital output 3, S- switching	
15	4- Digital output 4, S+ switching	
16	4+ Digital output 4, S- switching	
Terminal	Designation	Function (outputs)
17	5-	Digital output 5, S+ switching
18	5+	Digital output 5, S- switching
19	6-	Digital output 6, S+ switching
20	6+ Digital output 6, S- switching	
21	7- Digital output 7, S+ switching	
22	7+ Digital output 7, S- switching	
23	8-	Digital output 8, S+ switching
24	8+	Digital output 8, S- switching

Table 18: Terminal Assignment for the Digital Outputs

The digitial outputs can be configured in three ways:

- Digital output, one-pole switching without line diagnosis
- Digital output, two-pole switching without line diagnosis
- Digital output, two-pole switching with line diagnosis

Line diagnosis means line monitoring of digital outputs for short-circuits and open-circuits.

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F3 DIO 16/8 01 4 Start-Up

# 4.1.3.1 Overview of Configuration Variants for the Digital Outputs

The following table specifies all configurations variants for the digital outputs permitted for ELOP II Factory. Additional system signals have no influence on other variants (e.g., *Signal DO[xx].LS* monitoring with reduced voltage). With improper parameter setting, a diagnostic entry (*IOA Wrong Initial Data*) is generated. Simultaneously, the parameter setting is displayed. Use the table below to locate errors.

Configuration Variants for the Digital Outputs					
Application	Channel 1 two-pole	Channel 2 two-pole	Channel 1 LSLB	Channel 2 LSLB	Common ground
One-pole					
Two-pole		X <sup>1)</sup>			
		X <sup>1)</sup>		X <sup>1)</sup>	
	X <sup>1)</sup>				
	X <sup>1)</sup>		X <sup>1)</sup>		
	X <sup>1)</sup>	X <sup>1)</sup>			
	X <sup>1)</sup>	X <sup>1)</sup>		X <sup>1)</sup>	
	X <sup>1)</sup>	X <sup>1)</sup>	X <sup>1)</sup>		
	X <sup>1)</sup>	X <sup>1)</sup>	X <sup>1)</sup>	X <sup>1)</sup>	
Three-pole	X <sup>1)</sup>	X <sup>1)</sup>		X <sup>1)</sup>	X <sup>1)</sup>
	X <sup>1)</sup>	X <sup>1)</sup>			X <sup>1)</sup>
	X <sup>1)</sup>	X <sup>1)</sup>	X <sup>1)</sup>		X <sup>1)</sup>
	X <sup>1)</sup>	X <sup>1)</sup>	X <sup>1)</sup>	X <sup>1)</sup>	X <sup>1)</sup>
1) Option is selected					

Table 19: Configuration Variants for the Digital Outputs

# 4.1.4 Pulsed Outputs

Terminal assignment for the pulsed outputs.

Terminal	Designation	Function (non-safe pulsed outputs TO)		
25	1	Pulsed output 1		
26	1	Pulsed output 1		
27	1	Pulsed output 1		
28	1	Pulsed output 1		
29	2	Pulsed output 2		
30	2	Pulsed output 2		
31	2	Pulsed output 2		
32	2	Pulsed output 2		

Table 20: Terminal Assignment for the Pulsed Outputs

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### 4.1.5 Mounting the F3 DIO 16/8 01 in Zone 2

(EC Directive 94/9/EC, ATEX)

The remote I/O is suitable for mounting in zone 2. Refer to the corresponding declaration of conformity available on the HIMA website.

When mounting the device, observe the special conditions specified in the following section.

### Special Conditions X

1. Mount the remote I/O in an enclosure that meets the EN 60079-15 requirements and achieves a type of protection of at least IP54, in accordance with EN 60529. Provide the enclosure with the following label:

### Work is only permitted in the de-energized state

### Exception:

If a potentially explosive atmosphere has been precluded, work can also performed when the controller is under voltage.

- 2. The enclosure in use must be able to safely dissipate the generated heat. Depending on the output load and supply voltage, the HIMatrix F3 DIO 16/8 01 has a power dissipation ranging between 13 W and 31 W.
- Protect the HIMatrix F3 DIO 16/8 01 with a 12 A time-lag fuse.
   The remote I/O must be supplied with 24 VDC from a power supply unit with safe isolation. Use only power supply units of type PELV or SELV.
- 4. Applicable standards:

VDE 0170/0171 Part 16, DIN EN 60079-15: 2004-5 VDE 0165 Part 1, DIN EN 60079-14: 1998-08

Pay particular attention to the following sections

DIN EN 60079-15:

Chapter 5 Design

Chapter 6 Terminals and cabling
Chapter 7 Air and creeping distances

Chapter 14 Connectors

DIN EN 60079-14:

Chapter 5.2.3 Equipment for use in zone 2
Chapter 9.3 Cabling for zones 1 and 2
Chapter 12.2 Equipment for zones 1 and 2

The remote I/O is additionally equipped with the represented label:

HIMA

Paul Hildebrandt GmbH + Co KG A.-Bassermann-Straße 28, D-68782 Brühl

**HIMatrix** 

F3 DIO 16/8 01

Special Conditions X must be regarded!

Figure 10: Label for Ex Conditions

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0 °C < Ta < 60 °C

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# 4.2 Configuration

The remote I/O can be configured using a programming tool, SILworX or ELOP II Factory. Which programming tool should be used depends on the revision status of the operating system (firmware):

- ELOP II Factory is required for operating system versions prior to 7.
- SILworX is required for operating system version 7 and beyond.

i ELOP II Factory is required to load a new operating system (version 7 and beyond) into a remote I/O with a CPU operating system version prior to 7. SILworX is then required once the loading procedure is completed.

# 4.3 Configuring the Remote I/O with SILworX

In the Hardware Editor, the remote I/Os are represented like a base plate equipped with the following modules:

- Processor module (CPU)
- Input module (DI 16 LC) with Line Control
- Output module (DO 8 03)
- Pulsed module (DO 2 01) with 2 outputs

Double-click the module to open the Detail View with the corresponding tabs. The tabs are used to assign the global variables configured in the user program to the system parameter of the corresponding module.

## 4.3.1 Parameters and Error Codes for the Inputs and Outputs

The following tables specify the system parameters that can be read and set for the inputs and outputs, including the corresponding error codes.

In the user program, the error codes can be read using the variables assigned within the logic.

The error codes can also be displayed in SILworX.

## 4.3.2 Digital Inputs of F3 DIO 16/8 01

The following tables present the statuses and parameters for the input module (DI 16 LC) in the same order as given in the Hardware Editor.

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# 4.3.2.1 **Module** Tab

The **Module** tab contains the following system parameters.

System Signal	Data type	R/W	Description	
DI number	USINT	W	Number of pulsed outputs (supply outputs)	
Pulsed Channels			Coding [	Description
			c	No pulsed output planned for LS/LB <sup>1)</sup> detection
			c	Pulsed output 1 planned for LS/LB <sup>1)</sup> detection
			2 F	Pulsed outputs 1 and 2 planned for LS/LB <sup>1)</sup> detection
				must not be used as safety-related
			outputs!	
DI Supply [01]	BOOL	W	Triggering the single DI supplies	
DI Supply [02]	BOOL	W		Description
				Sensor Supply (1 A) is off.
				Sensor supply (1 A) is on.
			Default setting FALSE: Deeding current 40 mA	
DI Pulse Slot	UDINT	W	Pulse module slot (LS/LB <sup>1)</sup> detection), set the value to 3	
DI Pulse Delay (10E-6s)	UINT	W	Waiting time for line control (detection of short-circuits or cross-circuits)	
DI.Error Code	WORD	R	Error codes for all digital inputs	
			Coding [	Description
			0x0001 F	Fault within the digital inputs
			0x0002 F	FTT test of test pattern faulty
DI.Error Code	WORD	R	Error code of the DI supply unit as a whole:	
Supply			Coding [	Description
			0x0001 N	Module fault
DI[01].Error Code	BYTE	R	Triggering the single DI supplies	
Supply			Coding [	Description
DI[02].Error Code	BYTE	R	0x01 E	Error DI supply unit
Supply			0x02	Supply shutdown due to over current
			0x04 E	Error while reading back the supply

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System Signal	Data type	R/W	Description	
Module Error Code	WORD	R	Module error code	
			Coding	Description
			0x0000	I/O processing, if required with errors
				see other error codes
			0x0001	No I/O processing (remote I/O not in RUN)
			0x0002	No I/O processing during the booting test
			0x0004	Manufacturer interface operating
			0x0010	No I/O processing: wrong configuration
			0x0020	No I/O processing: fault rate exceeded
			0x0040/ 0x0080	No I/O processing: configured module not plugged in
Module SRS	UDINT	R	Slot number (System Rack Slot)	
Module Type	UINT	R	Type of module, target value: 0x00E2 [226 dez]	
1) LS/LB (short-circuit/open-circuits)				

Table 21: SILworX - System Parameters for Digital Inputs, **Module** Tab

# 4.3.2.2 **DI 16 LC: Channels** Tab

The **DI 16 LC**: **Channels** tab contains the following system parameters.

System Signal	Data type	R/W	Description	
Channel no.		R	Channel number, defined by default	
-> Error Code	BYTE	R	Error codes for the digital input channels	
[BYTE]			Coding	Description
			0x01	Fault in the digital input module
			0x10	Short-circuit of the channel
			0x80	Intermittence between pulsed output TO and digital input DI, e.g.,  Open-circuit Open switch L+ low voltage
-> Value [BOOL]	BOOL	R	Input values for the digital input channels 0 = input de-energized 1 = input energized	
Pulsed Channels	USINT	W	Source channel for pulsed supply	
[USINT] ->			Coding	Description
			0	Input channel
			1	Pulse of the 1st TO channel
			2	Pulse of the 2nd TO channel

Table 22: SILworX - System Parameters for Digital Inputs, **DI 16 LC: Channels** Tab

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# 4.3.3 Digital Outputs of F3 DIO 16/8 01

The following table presents the statuses and parameters for the output module (DO 8 03) in the same order given in the SILworX Hardware Editor.

## 4.3.3.1 **Module** Tab

The **Module** tab contains the following system parameters.

System Signal	Data type	R/W	Description	
DO.Error Code	WORD	R	Error codes for all digital outputs	
			Coding	Description
			0x0001	Fault within the digital outputs
			0x0002	MOT test of safety shutdown returns a fault
			0x0004	MOT test of auxiliary voltage returns a fault
			0x0008	FTT test of test pattern faulty
			0x0010	MOT test of output switch test pattern faulty
			0x0020	MOT test of output switch test pattern
			00040	(shutdown test of the outputs) faulty
			0x0040	MOT test active shutdown via WD faulty
			0x0080	FTT test of monitoring time returns a fault
			0x0100	FTT read back of monitoring time returns a fault
			0x0200	All outputs are switched off, total current exceeded
			0x0400	FTT test: 1st temperature threshold exceeded
			0x0800	FTT test: 2nd temperature threshold exceeded
			0x1000	FTT test: Monitoring of auxiliary voltage 1: Low voltage
			0x2000	FTT test: Monitoring of auxiliary voltage 2: Low voltage
			0x4000	Flipflop of the voltage monitoring (18V) provides low voltage
			0x8000	MOT test of monitoring time returns a fault
DO.Line	UINT	W	Monitoring time for line diagnosis in [ms],	
Monitoring Time			Range 150 ms, Default: 0 ms	
DO.LS/LB Interval	WORD	W	Period [s] required for line diagnosis Range 1100 s, 1 s steps	
DO[XX].LS	BOOL	W Line diagnosis with reduced voltage		
Monitoring with		••   '	Coding	Description
red. Voltage			FALSE	Normal signal voltage level
			TRUE	Reduced signal voltage level
			<u> </u>	al voltage level only at DO[xx].LSLB
			Monitoring = 1	

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System Signal	Data type	R/W	Description		
DO.[xx][xx].in pairs	BOOL	W	Common ground for each pair (DO- outputs form the common ground)		
			Coding	Description	
			FALSE	No common ground for each pair	
			TRUE	Common ground for each pair	
			Default value:	0	
				nel 1 [01] and channel 2 [02]	
				nel 3 [03] and channel 4 [04]	
				nel 5 [05] and channel 6 [06]	
	14/000	_		nel 7 [07] and channel 8 [08]	
Module Error Code	WORD	R	Module error code		
			Coding	Description	
			0x0000	I/O processing, if required with errors, see other error codes	
			0x0001	No I/O processing (remote I/O not in RUN)	
			0x0002	No I/O processing during the booting test	
			0x0004	Manufacturer interface operating	
			0x0010	No I/O processing: wrong configuration	
			0x0020	No I/O processing: fault rate exceeded	
			0x0040/ 0x0080	No I/O processing: configured module not plugged in	
Module SRS	UDINT	R	Slot number (S	system Rack Slot)	
Module Type	UINT	R	Type of module, target value: 0x00C4 [196 <sub>dec</sub> ]		

Table 23: SILworX - System Parameters for Digital Outputs, **Module** Tab

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## 4.3.3.2 **DO 8 03: Channels** Tab

The **DO 8 03: Channels** tab contains the following system parameters.

System Signal	Data type	R/W	Description		
Channel no.		R	Channel number, defined by default		
-> + Error Code	WORD	R	Error codes for the digital output channels DO+		
[WORD]			Error codes for the digital output channels DO-		
-> - Error Code	WORD	R			
[WORD]			Coding	Description	
			0x0001	Fault in the digital output module	
			0x0002	Channel shutdown due to overload	
			0x0004	Error while reading back the digital outputs	
			0x0008	Error while reading back the status of the digital outputs	
			0x0010	Short-circuit	
			0x0020	Channel is switched off due to fault on the corresponding channel	
			0x0040	Z-diode are destroyed at the output	
			0x0080	Open-circuit	
			0x0100	MOT test of the output switches provides in DO+ line causes an error	
			0x0200	MOT test of the output switches provides in DO- line causes an error	
			0x0400	MOT test of the test switches L- causes an error	
			0x0800	External supply L+ at DO+	
+ Value [BOOL]	BOOL	W		for DO+ channels, one-pole (value: 0 or 1) for DO+ channels, two-pole, identical to DO-	
- Value [BOOL]	BOOL	W	Output value for DO- channels, one-pole (value: 0 or 1) Output value for DO- channels, two-pole, identical to DO+ (Value: 0 or 1)		
Two-Pole [BOOL]	BOOL	W	Configuration	for a two-pole channel	
			Coding	Description	
			FALSE	Channel used for a 1-pole	
			TRUE	Channel used for a 2-pole	
Line Monitoring	BOOL	W	Configuration	of line diagnosis	
[BOOL] ->			Coding	Description	
			FALSE	LSLB <sup>1)</sup> diagnosis is not performed	
			TRUE	LSLB <sup>1)</sup> diagnosis is performed	
1) LS/LB (short-circuit	open-circui	ts)	,		

Table 24: SILworX - System Parameters for Digital Outputs, **DO 8 03: Channels** tab

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## 4.3.4 Pulsed Outputs for F3 DIO 16/8 01

The following table presents the statuses and parameters for the pulse module (DO 2 01) in the same order given in the SILworX Hardware Editor.

#### 4.3.4.1 **Module** Tab

The **Module** tab contains the following system parameters.

System Signal	Data type	R/W	Description		
DO.Error Code	WORD	R	Module error c	ode	
			Coding	Description	
			0x0001	Error of the TO unit as a whole:	
Module Error Code	WORD	R	Module error c	ode	
			Coding	Description	
			0x0000	I/O processing, if required with errors, see other error codes	
			0x0001	No I/O processing (remote I/O not in RUN)	
			0x0002	No I/O processing during the booting test	
			0x0004	Manufacturer interface operating	
			0x0010	No I/O processing: wrong configuration	
			0x0020	No I/O processing: fault rate exceeded	
			0x0040/ 0x0080	No I/O processing: configured module not plugged in	
Module SRS	UDINT	R	Slot number (System Rack Slot)		
Module Type	UINT	R	Type of module, target value: 0x00D3 [211 <sub>dec</sub> ]		

Table 25: SILworX - System Parameters for Pulsed Outputs, Module Tab

### **4.3.4.2 DO 2 01: Channels** Tab

The **DO 2 01: Channels** tab contains the following system parameters.

System Signal	Data type	R/W	Description					
Channel no.		R	Channel numb	er, defined by default				
-> Error Code [BYTE]	WORD	R	Error code of the individual digital pulsed output channels:					
			Coding	Description				
			0x01	Fault in the digital output module				
Value [BOOL] ->	BOOL	R	Output value for TO channels:					
			Coding	Description				
			FALSE	Output de-energized				
						TRU	TRUE	Output energized
			Do not use pu	Ilsed outputs as safety-related outputs!				

Table 26: SILworX - System Parameters for Pulsed Outputs, Module Tab

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### 4.4 Configuring a Module Using ELOP II Factory

## 4.4.1 Configuring the Inputs and Outputs

The signals previously defined in the Signal Editor (Hardware Management) are assigned to the individual channels (inputs and outputs) using ELOP II Factory. Refer to the System Manual for Compact Systems or the online help for more details

The following chapter describes the system signals used for assigning signals in the remote I/O.

### 4.4.2 Signals and Error Codes for the Inputs and Outputs

The following tables specify the system signals that can be read and set for the inputs and outputs, including the corresponding error codes.

In the user program, the error codes can be read using the signals assigned within the logic.

The error codes can also be displayed in ELOP II Factory.

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# 4.4.3 Digital Inputs of F3 DIO 16/8 01

System Signal	R/W	Description	1	
Mod.SRS [UDINT]	R	Slot number (System Rack Slot)		
Mod. Type [UINT]	R	Type of module, target value: 0x00E2 [226 dez]		
Mod. Error Code [WORD]	R	Module err	or code	
		0x0000	I/O processing, if required with errors, see other error codes	
		0x0001	No I/O processing (remote I/O not in RUN)	
		0x0002	No I/O processing during the booting test	
		0x0004	Manufacturer interface operating	
		0x0010	No I/O processing: wrong configuration	
		0x0020	No I/O processing: fault rate exceeded	
		0x0040/	No I/O processing: configured module not plugged in	
		0x0080		
DI.Error Code Supply	R		of the DI supply unit as a whole:	
[WORD]		0x0001	Module fault	
DI[xx].Error Code Supply	R		the single DI supplies	
[BYTE]		0x01	Error DI supply unit	
		0x02	Supply shutdown due to over current	
		0x04	Error while reading back the supply	
DI.Error Code [WORD]	R	Error code	s for all digital inputs	
		0x0001	Fault within the digital inputs	
		0x0002	FTT test of test pattern faulty	
DI[xx].Error Code [BYTE]	R	Error codes for the digital input channels		
		0x01	Fault in the digital input module	
		0x10	Short-circuit of the channel	
		0x80	Intermittence between pulsed output TO and digital	
			input DI, e.g.,	
			<ul><li>Open-circuit</li><li>Open switch</li></ul>	
			L+ low voltage	
DI[xx].Value [BOOL]	R	Input value	es for the digital input channels	
		0	Input de-energized	
		1	Input enerized	
DI Number of	W	Number of	pulsed outputs (supply outputs)	
Pulsed Channels [USINT]		0	No pulsed output planned for LS/LB <sup>1)</sup> detection	
		1	Pulsed output 1 planned for LS/LB <sup>1)</sup> detection	
		2	Pulsed outputs 1 and 2 planned for LS/LB <sup>1)</sup> detection	
			tputs must not be used as safety-related outputs!	
DI Supply[xx] [BOOL]	W	Triggering	the single DI supplies	
		0	Sensor supply (1 A) is off.	
		1	Sensor supply (1 A) is on.	
			ting 0: feeding current 40 mA	
DI Pulse	W	Pulse module slot		
Slot [UDINT]		(LS/LB <sup>1)</sup> detection), set the value to 3		
DI[xx].Pulsed Channel	W		nnel for pulsed supply	
[USINT]	[	0	Input channel	
		1	Pulse of the 1st TO channel	
		2	Pulse of the 2nd TO channel	

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System Signal	R/W	Description
DI Pulse Delay [10E-6 s] [UINT]	W	Waiting time for line control (detection of short-circuits or cross-circuits)
1) LS/LB (short-circuit/ope	n-circuits	5)

Table 27: ELOP II Factory - Digital Input System Signals

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# 4.4.4 Digital Outputs of F3 DIO 16/8 01

System Signal	R/W	Description		
Mod.SRS [UDINT]	R	Slot number	er (System Rack Slot)	
Mod. Type [UINT]	R	Type of mo	odule, target value: 0x00C4 [196 <sub>dec</sub> ]	
Mod. Error Code [WORD]	R	Module err	or code	
		0x0000	I/O processing, if required with errors, see other error codes	
		0x0001	No I/O processing (remote I/O not in RUN)	
		0x0002	No I/O processing during the booting test	
		0x0004	Manufacturer interface operating	
		0x0010	No I/O processing: wrong configuration	
		0x0020	No I/O processing: fault rate exceeded	
		0x0040/ 0x0080	No I/O processing: configured module not plugged in	
DO.Error Code [WORD]	R		s for all digital outputs	
		0x0001	Fault within the digital outputs	
		0x0002	MOT test of safety shutdown returns a fault	
		0x0004	MOT test of auxiliary voltage returns a fault	
		0x0008	FTT test of test pattern faulty	
		0x0010	MOT test of output switch test pattern faulty	
		0x0020	MOT test of output switch test pattern	
			(shutdown test of the outputs) faulty	
		0x0040	MOT test active shutdown via WD faulty	
		0x0080	FTT test of monitoring time returns a fault	
		0x0100	FTT read back of monitoring time returns a fault	
		0x0200	All outputs are switched off, total current exceeded	
		0x0400	FTT test: 1st temperature threshold exceeded	
		0x0800	FTT test: 2nd temperature threshold exceeded	
		0x1000	FTT test: Monitoring of auxiliary voltage 1: Low voltage	
		0x2000	FTT test: Monitoring of auxiliary voltage 2: Low voltage	
		0x4000	Flipflop of the voltage monitoring (18V) provides low voltage	
		0x8000	MOT test of monitoring time returns a fault	
DO[xx].+Error Code	R		s for the digital output channels DO+	
DO[xx]Error Code	R		s for the digital output channels DO-	
[WORD]		0x0001	Fault in the digital output module	
		0x0002	Channel shutdown due to overload	
		0x0004	Error while reading back the digital outputs	
		0x0008	Error while reading back the status of the digital outputs	
		0x0010	Short-circuit	
		0x0020	Channel is switched off due to fault on the corresponding channel	
		0x0040	Z-diode at the output destroyed	
		0x0080	Open-circuit	
		0x0100	MOT test of the output switches provides in DO+ line causes an error	
		0x0200	MOT test of the output switches provides in DO- line causes an error	
		0x0400	MOT test of the test switches L- causes an error	

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System Signal	R/W	Description		
		0x0800 External supply L+ at DO+		
DO.LSLB period [WORD]	W	Period [s] required for the line diagnosis		
		Range 1100 s, 1 s steps		
DO.LSLB monitoring time	W	Monitoring time for line diagnosis in [ms],		
[UINT]		Range 150 ms, Default: 0 ms		
DO2[xx].Two-Pole [BOOL]	W	Configuration for a two-pole channel		
		0 Channel used for a 1-pole		
		1 Channel used for a 2-pole		
DO[xx].+Value [BOOL]	W	Output value for DO+ channels, one-pole (value: 0 or 1) Output value for DO+ channels, two-pole, identical to DO- (Value 0 or 1)		
DO[xx]Value [BOOL]	W	Output value for DO- channels, one-pole (value: 0 or 1)		
		Output value for DO- channels, two-pole, identical to DO+		
		(Value: 0 or 1)		
DO[xx].LSLB Monitoring	W	Configuration of line diagnosis		
[BOOL]		0 LSLB <sup>1)</sup> diagnosis is not performed		
		1 LSLB <sup>1)</sup> diagnosis is performed		
DO[xx].LS Monitoring with	W	Line diagnosis with reduced voltage		
reduced voltage [BOOL]		0 Normal signal voltage level		
		1 Reduced signal voltage level		
		(Reduced signal voltage level only at DO[xx].LSLB		
		Monitoring = 1 effective!)		
DO[xx][xx].in pairs	W	Common ground for each pair		
[BOOL]		(DO- outputs form the common ground)		
		0 No common ground for each pair		
		1 Common ground for each pair		
		Default value: 0		
		Pair 1 = Channel 1 [01] and channel 2 [02]		
		Pair 2 = Channel 3 [03] and channel 4 [04]		
		Pair 3 = Channel 5 [05] and channel 6 [06] Pair 4 = Channel 7 [07] and channel 8 [08]		
1)	<u> </u>			
1) LS/LB (short-circuit/open	-circuits	)		

Table 28: ELOP II Factory - Digital Output System Signals

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## 4.4.5 Pulsed Outputs for F3 DIO 16/8 01

System Signal	R/W	Description			
Mod.SRS [UDINT]	R	Slot number	Slot number (System Rack Slot)		
Mod. Type [UINT]	R	Type of mod	Type of module, target value: 0x00D3 [211 <sub>dec</sub> ]		
Mod. Error Code [WORD]	R	Module erro	r code		
		0x0000	I/O processing, if required with errors, see other error codes		
		0x0001	No I/O processing (remote I/O not in RUN)		
		0x0002	No I/O processing during the booting test		
		0x0004	Manufacturer interface operating		
		0x0010	No I/O processing: wrong configuration		
		0x0020	No I/O processing: fault rate exceeded		
		0x0040/ 0x0080	No I/O processing: configured module not plugged in		
DO.Error Code [WORD]	R	Error code o	f the TO unit as a whole		
		0x0001	Error of the TO unit as a whole:		
DO[xx].Error Code	R	Error code o	f the individual digital pulsed output channels:		
[BYTE]		0x01	Fault in the digital output module		
DO[xx].Value [BOOL]	W	Output value for TO channels:			
		0	Output de-energized		
		1	Output energized		
		Do not use	pulsed outputs as safety-related outputs!		

Table 29: ELOP II Factory - System Signals for the Pulsed Outputs

## 4.5 Configuration of Line Diagnosis

To diagnose the line for ohmic capacitive loads, the remote I/O sends a 10V test pulse (reduced voltage level) to the output circuit for the duration of the monitoring time. This type of line diagnosis is particularly recommended for ohmic and ohmic capacitive loads. With inductive loads or lamp loads, error messages related to the short-circuit may be generated.

To configure the line diagnosis, the following parameters must be set in SILworX and the following signals must be set in ELOP II Factory Hardware Management.

SILworX	ELOP II Factory	Value
DO.LS/LB Interval	DO.LSLB Interval	Free configurable 1100 s
DO.Line Monitoring Time	DO.LSLB Monitoring Time	Free configurable 050 ms Default: 0 ms
Two-Pole [BOOL] ->	DO[xx].Two-Pole	TRUE
Line Monitoring [BOOL] ->	DO[xx].LSLB Monitoring	TRUE
DO[XX].LS Monitoring with red. voltage	DO[XX].LS Monitoring with red. voltage	TRUE

Table 30: Configuration of Line Diagnosis with Reduced Voltage with Ohmic Capacitive Loads

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#### 4.6 Connection Variants

This chapter describes the correct wiring of device in safety-related applications.

#### 4.6.1 One-Pole Connection

For 1-pole applications, the outputs DO+ must be connected to supply S- (load on S-) and the outputs DO- must be connected to the supply S+ (load on S+).

In this case, 8 outputs DO+ and 8 outputs DO- are available.

No line diagnosis is possible for one-pole applications.

 $\dot{1}$  A direct connection of the DO+ output to the external L- via the load or a connection of DO-output to external L- via the load is not permitted!

Inductive loads may be connected with no free-wheeling diode on the actuator. However, HIMA strongly recommends connecting a protective diode directly to the actuator.

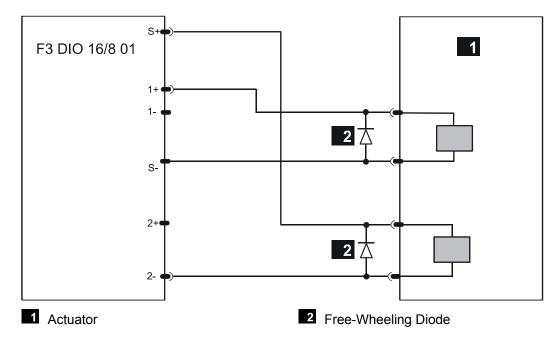


Figure 11: One-Pole Connection of an Actuator to the DO+ or DO- Output

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#### 4.6.2 Two-Pole Connection

The DO+ output and DO- output of a channel are required for two-pole applications. In each channel, the DO+ output is permanently assigned to DO- output.

In this case, 8 channels with 16 outputs are available.

To allow two-pole connection, the corresponding channels must be configured using the DO[xx]2-pole [BOOL] system signal.

In a 2-pole connection, no DI input must be connected to a DO output. This would inhibit the detection of open-circuits.

The DO+ output must be connected to the DO- output of the same channel via the actuator. DO+ outputs must not be connected with one another and DO- outputs must not be connected with one another.

Exception: in pairs wiring

Inductive loads must be connected with free-wheeling diode on the actuator.  $\boldsymbol{1}$ 

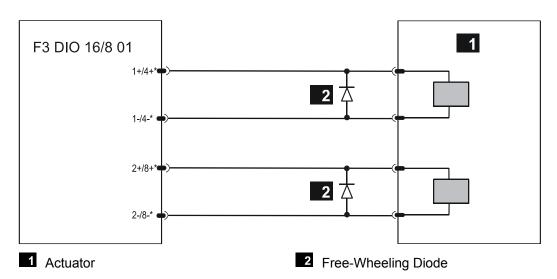


Figure 12: Two-Pole Connection of an Actuator

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### 4.6.3 Two-pole Connection with Common Ground

Two-pole channels can be interconnected on a common ground to allow line diagnosis, e.g., with motors (dual motor drivers) or dual valves. The common ground is created via the DO outputs of the channels concerned. To do so, the DO[xx][xx]. In Pairs system parameter must be configured for each pair (2 channels). For further configuration variants, also refer to Table 23 and Table 28. If the line diagnosis is configured in pairs on both two-pole channels (channel 1 and 2, channel 3 and 4, channel 5 and 6, channel 7 and 8), line diagnosis is performed. To this end, set the Line Monitoring [BOOL] -> system variable in SILworX to TRUE and the DO[xx]-LSLB Monitoring system signal in ELOP II Factory to TRUE. If a test is performed on one channel, the second channel is switched off to ensure that the line diagnosis is not distorted.

A short-circuit between the two DO+ lines is not detected.

A detected line fault is reported to the user:

- In SILworX, with the system variables -> + Error Code [WORD] or -> Error Code [WORD].
- In ELOP II Factory, with the system signals DO[xx].+Error Code or DO[xx].-Error Code.

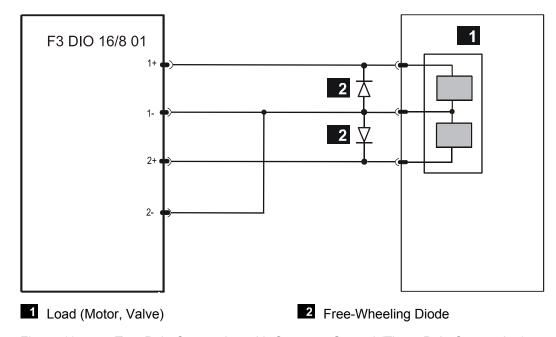


Figure 13: Two-Pole Connection with Common Ground (Three-Pole Connection)

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F3 DIO 16/8 01 5 Operation

## 5 Operation

The remote I/O can only operated together with a controller. No specific monitoring is required for remote I/Os.

## 5.1 Handling

Handling of the remote I/O during operation is not required.

#### 5.2 Diagnosis

A first diagnosis results from evaluating the LEDs, see Chapter 3.4.1. The remote I/O writes diagnostic entries in the diagnostic memory of the connected controller.

## 5.2.1 Diagnostic Entries

The remote I/O has extended diagnostic entry options. For more information, refer to the System Manual for Compact Systems (HI 800 001 E), Chapter *Diagnosis*. These options are intended to support the user when configuring the line diagnosis and detecting errors.

Faulty parameter setting

- · IOA: wrong LS/LB parameters on channel pair
- IOA: wrong open-circuit or short-circuit monitoring time: (at maximum ... ms are allowed)
- IOA: wrong open-circuit or short-circuit monitoring time: (at minimum ... s are allowed)
- IOA: wrong open-circuit or short-circuit monitoring time: (at maximum ... s are allowed)

The messages specified above are stored to the long-term and short-term diagnosis.

#### Channel fault:

Each faulty channel is registered in one row of the diagnosis. This row identifies the channel with the corresponding output/branch.

Example: Faulty channel 1 on both branches

IO CHANNEL ERROR: Slot:2 I/O module type:00C4 channel:1 status[L plus:0080 L minus:0080]

The message specified above is only stored to the short-term diagnosis.

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6 Maintenance F3 DIO 16/8 01

#### 6 Maintenance

No maintenance measures are required during normal operation.

If a device or module fails, it must be replaced with a faultless device or module of the same type or with an approved replacement model.

Only the manufacturer is authorized to repair the device/module.

#### 6.1 Faults

Refer to Chapter 3.1.1.1, for more information on the fault reaction of digital inputs.

Refer to Chapter 3.1.3.1, for more information on the fault reaction of digital outputs.

#### 6.1.1 Operating System Version 6.42 and Beyond

If the test harnesses detect faults in the processor system, the remote I/O enters the STOP\_INVALID state and is restarted (RUN state) by the associated controller. If a further internal fault occurs within the first minute after start-up, the device enters the STOP\_INVALID state and will remain in this state. This means that the input signals are no longer processed by the device and the outputs switch to the de-energized, safe state. The evaluation of diagnostics provides information on the fault cause.

### 6.1.2 Operating System Versions Prior to 6.42

If the test harnesses detect faults in the processor system, the module automatically enters the ERROR STOP state and will remain in this state. This means that the input signals are no longer processed by the device and the outputs switch to the de-energized, safe state. The evaluation of diagnostics provides information on the fault cause.

#### 6.2 Maintenance Measures

The following measures are required for the processor module:

- Loading the operating system, if a new version is required
- Executing the proof test

### 6.2.1 Loading the Operating System

HIMA is continuously improving the operating system of the devices. HIMA recommends to use system downtimes to load a current version of the operating system into the devices.

Refer to the release list to check the consequences of the new operation system version on the system!

Load the operating system using the programming tool.

Prior to loading the operating system, the device must be in STOP (displayed in the programming tool). Otherwise, stop the device.

For more information, refer to the programming tool documentation.

#### 6.2.2 Proof Test

Test the HIMatrix devices and modules every 10 years. For more information, refer to the Safety Manual (HI 800 003 E).

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F3 DIO 16/8 01 7 Decommissioning

# 7 Decommissioning

Remove the supply voltage to decommission the device. Afterwards pull out the pluggable screw terminal connector blocks for inputs and outputs and the Ethernet cables.

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8 Transport F3 DIO 16/8 01

## 8 Transport

To avoid mechanical damage, HIMatrix components must be transported in packaging.

Always store HIMatrix components in their original product packaging. This packaging also provides protection against electrostatic discharge. Note that the product packaging alone is not suitable for transmission.

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F3 DIO 16/8 01 9 Disposal

# 9 Disposal

Industrial customers are responsible for correctly disposing of decommissioned HIMatrix hardware. Upon request, a disposal agreement can be arranged with HIMA.

All materials must be disposed of in an ecologically sound manner.

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Appendix F3 DIO 16/8 01

# **Appendix**

## **Glossary**

Term	Description
ARP	Address Resolution Protocol: Network protocol for assigning the network addresses
	to hardware addresses
Al	Analog Input
COM	COMmunication module
CRC	Cyclic Redundancy Check
DI	Digital Input
DO	Digital Output
ELOP II Factory	Programming tool for HIMatrix systems
EMC	ElectroMagnetic Compatibility
EN	European Norm
ESD	ElectroStatic Discharge
FB	FieldBus
FBD	Function Block Diagrams
FTA	Field Termination Assembly
FTT	Fault Tolerance Time
ICMP	Internet Control Message Protocol: Network protocol for status or error messages
IEC	International Electrotechnical Commission
MAC address	Media Access Control address: Hardware address of one network connection
PADT	Programming And Debugging Tool (in accordance with IEC 61131-3), PC with SILworX or ELOP II Factory
PE	Protective Earth
PELV	Protective Extra Low Voltage
PES	Programmable Electronic System
PFD	Probability of Failure on Demand, probability of failure on demand of a safety function
PFH	Probability of Failure per Hour, probability of a dangerous failure per hour
R	Read: The system variable or signal provides value, e.g., to the user program
Rack ID	Base plate identification (number)
Non-reactive	Supposing that two input circuits are connected to the same source (e.g., a transmitter). An input circuit is termed <i>non-reactive</i> if it does not distort the signals of the other input circuit.
R/W	Read/Write (column title for system variable/signal type)
SB	System Bus (module)
SELV	Safety Extra Low Voltage
SFF	Safe Failure Fraction, portion of safely manageable faults
SIL	Safety Integrity Level (in accordance with IEC 61508)
SILworX	Programming tool for HIMatrix systems
SNTP	Simple Network Time Protocol (RFC 1769)
S.R.S	System.Rack.Slot addressing of a module
SW	Software
TMO	TiMeOut
W	Write: System variable/signal is provided with value, e.g., from the user program
WD	WatchDog: Time monitoring for modules or programs. If the watchdog time is exceeded, the module or program enters the ERROR STOP state.
WDT	WatchDog Time
L	· -

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HIMA Paul Hildebrandt GmbH + Co KG
P.O. Box 1261
68777 Brühl, Germany
Tel: +49 6202 709-0

Fax: +49 6202 709-107